

Small Signal Fast Switching Diode

General Description

Dual general-purpose switching diodes, fabricated in planar technology, and packaged in small SOT-23F surface mounted device (SMD) packages.

Features and Benefits

- Silicon epitaxial planar diode
- High switching speed: trr≤4ns
- Low forward drop voltage and low leakage current
- Full lead (Pb)-free device and RoHS compliant device
- Available in "Green" device

Applications

• Ultra high speed switching application

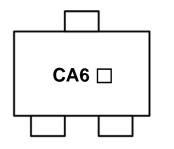
Ordering Information





Part Number	Marking Code	Package	Packaging
SDS2838F	CA6 🗆	SOT-23F	Tape & Reel

Marking Information



CA6 = Specific Device Code

□ = Year & Week Code Marking

Pinning Information

Pin	Description	Simplified Outline	Graphic Symbol
1	Anode (Diode 1)	3	<u>_</u>
2	Anode (Diode 2)		× ×
3	Common Cathode	1 2	

Absolute Maximum Ratings (T_{amb}=25°C, Unless otherwise specified)

Characteristic	Symbol	Ratings	Unit
Maximum repetitive peak reverse voltage	V _{RM}	85	V
Continuous reverse voltage	V _R	80	V
Maximum average forward rectified current	lo	100	mA
Forward current (DC)	l _F	100	mA
Maximum repetitive peak forward current	I _{FM}	300	mA
Non-repetitive peak forward surge current(t=10ms)	I _{FSM}	2	А
Power dissipation ¹⁾	P _D	150	mW

¹⁾ Device mounted on FR-4 board with recommended pad layout.

Thermal Characteristics (T_{amb}=25°C, Unless otherwise specified)

Characteristic	Symbol	Ratings	Unit
Thermal resistance, junction to ambient 1)	R _{th(j-a)}	830	°C/W
Operating junction temperature	Tj	150	°C
Storage temperature range	T _{stg}	-55 ~ 150	°C

¹⁾ Device mounted on FR-4 board with recommended pad layout.

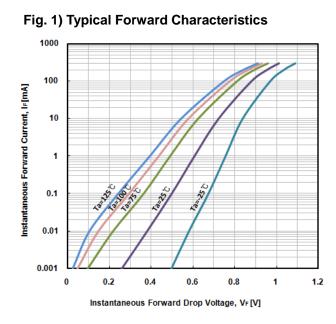
Electrical Characteristics (T_{amb}=25°C, Unless otherwise specified)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Forward voltage ²⁾	V _{F(1)}	I _F =1mA	-	0.6	-	V
	$V_{F(2)}$	I _F =10mA	-	0.7	-	V
	V _{F(3)}	I _F =100mA	-	0.9	1.2	V
Reverse leakage current 3)	I _R	V _R =80V	-	-	0.5	uA
Total capacitance	C _T	V _R =0V, f=1 ^{MHz}	-	2.2	4.0	pF
Reverse recovery time	t _{rr}	I _F =10mA (Fig. 5)	-	1.6	4.0	ns

²⁾ Pulse test: $t_P \leq 380 \mu s$, Duty cycle $\leq 2\%$

 $^{3)}$ Pulse test: $t_{P}{\leq}5\text{ms},$ Duty cycle ${\leq}2\%$

Rating and Characteristic Curves



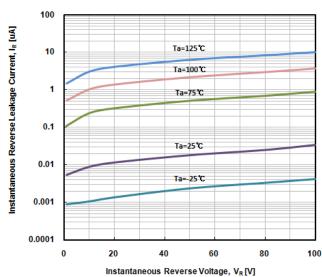
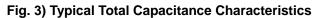
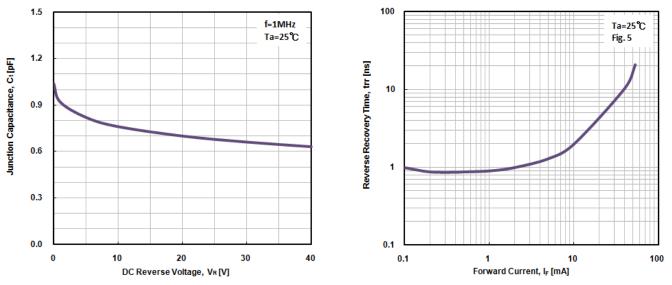
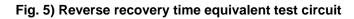


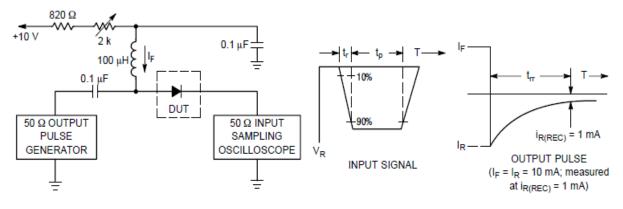
Fig. 4) Reverse Recovery Time vs. Forward Current

Fig. 2) Typical Reverse Characteristics

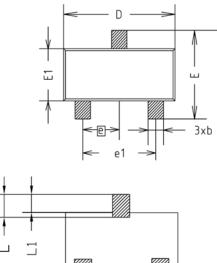


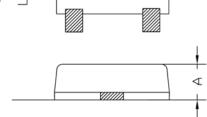


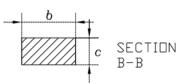


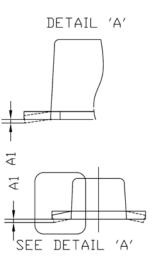


Package Outline Dimensions



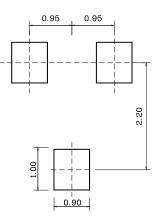






SYMBOL	١	NOTE		
STADUL	MINIMUM	NOMINAL	MAXIMUM	NUTE
Α	0.80	0.90	1.00	
A1	0.00	-	0.10	
b	0.35	0.40	0.45	
C	0.10	0.15	0.20	
D	2.80	2.90	3.00	
E	2.30	2.40	2.50	
E1	1.50	1.60	1.70	
e	0.95BSC			
e1	1.80	1.90	2.00	
L	0.48	0.58	0.68	
L1	0.30	-	0.50	

※ Recommend PCB solder land (Unit : mm)



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